

TAI-SAW TECHNOLOGY CO., LTD.

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Product Specifications Approval Sheet

Product Name: TC	XO SMD 1.6x1.2	2 26.00MHz	
TST Part No.: TX1	010BA1064		
Customer Part No.	:		
Company:			
Division:			
Approved by:_			
Date:			
Checked by:	Tom Liu	TE	m
Approved by:	Kelly Huang	Kelly	Juanes
Date:	04/11/2023	,]	J

- 1. Customer signed back is required before TST can proceed with sample build and receive orders.
- 2. Orders received without customer signed back will be regarded as agreement on the specifications.
- 3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.

MODEL NO.: TX1010BA1064 REV. NO.: 2

Revise:

Rev.	Rev.Page	Rev. Account	Date	Ref. No.	Revised by
1	N/A	Initial release	11/09/22	N/A	Tom Liu
2	4	Revise product thickness:	04/11/23'	ECN-202300164	Tom Liu
		0.7±0.1→0.7 max			



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TCXO SMD 1.6x1.2 26.00MHz

MODEL NO.: TX1010BA1064 REV. NO.: 2

Features:

- Ultra Miniature SMD Package
- Good Frequency Stability
- Good Phase Noise Response
- Moisture Sensitivity Level (MSL): Level-1
- AEC-Q200 (IC: AEC-Q100) compliant



Description and Applications:

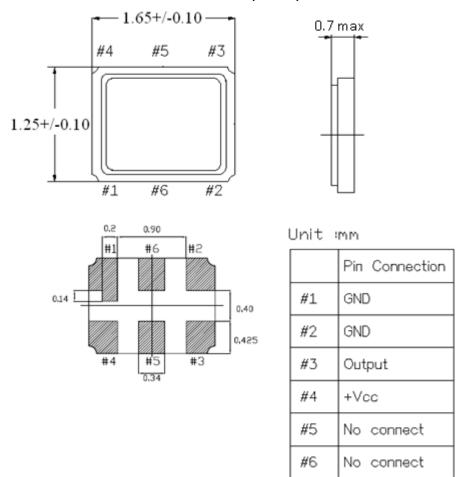
Surface mount 1.6mmx1.2mm TCXO for use in wireless communications devices

Electrical Specifications:

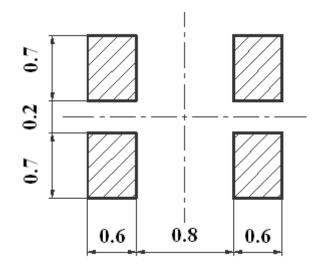
TX1010BA1064	Specifications				
Nominal Frequency, Fo	26.000000 MHz				
Storage Temperature Range	-40°C to +85°C				
Operating Temperature Range	-40°C to +85°C				
Power Supply Voltage, Vcc	1.8V ± 5%				
Output Voltage with Load 10pF//10KΩ, Vout	0.8 Vp-p min				
Output Waveform	Clipped Sinewave				
Output Load	10pF//10KΩ				
Power Supply Current, Icc	2.0 mA max				
Frequency Tolerance as Received Ref. to Nominal Frequency	+/- 0.5 ppm max @ 25°C +/- 3°C				
Frequency Deviation after 2 x Reflow Ref. to pre-reflow Freq.	+/- 1.0 ppm max @ 25°C +/- 3°C				
Frequency Stability a. Vs. Temperature (-30~85°C) Vs. Temperature (-40~-30°C) b. Vs. Load varied 10pF//10KΩ+/-10% c. Vs. Supply Voltage varied Vcc+/-5%	+/- 0.5 ppm reference to the middle point between minimum and maximum frequency value +/- 2.0 ppm +/- 0.1 ppm +/- 0.1 ppm				
Start Up Time	2.0 msec max.				
Harmonics	-5.0 dBc max				

Aging	+/-1.0 ppm/year max @25°C first year
SSB Phase Noise (@1kHz Carrier Offset)	-130 dBc/Hz max
Marking	Laser marking

Mechanical Dimensions (mm):



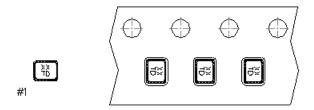
Recommended Land Pattern: (unit: mm)



Marking:

Line 1: XX; Frequency (26)

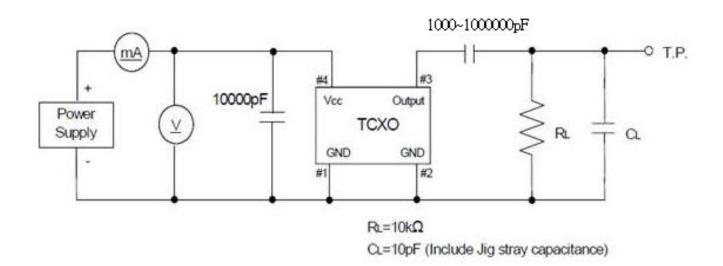
Line 2: T; Traceable Code + D; date Code of Year/Month



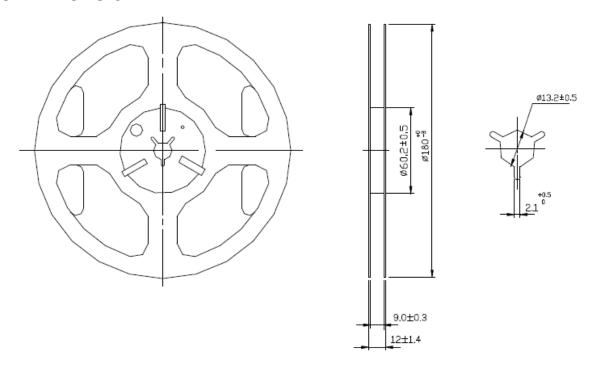
Date Code Table: Year/Month

Year/Month	1	2	3	4	5	6	7	8	9	10	11	12
2017	n	р	q	r	s	t	u	٧	W	х	у	Z
2018	Α	В	С	D	E	F	G	Н	J	K	L	М
2019	N	Р	Q	R	S	Т	U	٧	W	Х	Υ	Z
2020	а	b	С	d	е	f	g	h	i	j	k	m
2021	n	р	q	r	s	t	u	٧	W	х	у	Z
2022	Α	В	С	D	E	F	G	Н	J	K	L	М
2023	N	Р	Q	R	S	Т	U	V	W	Х	Υ	Z

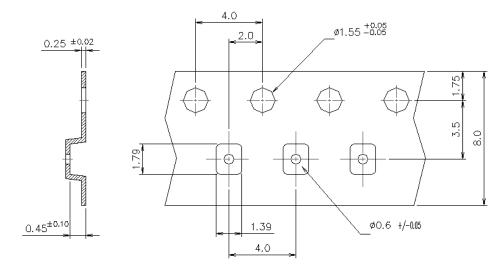
Recommended Circuit



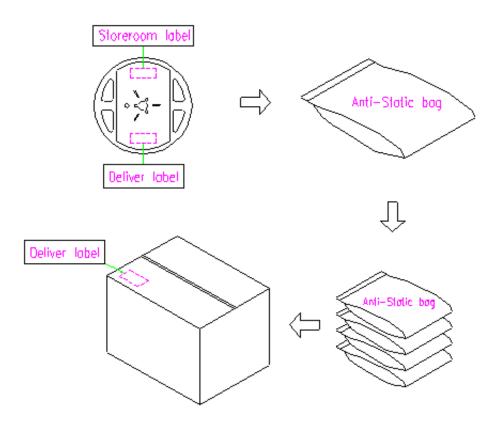
Reel Dimension



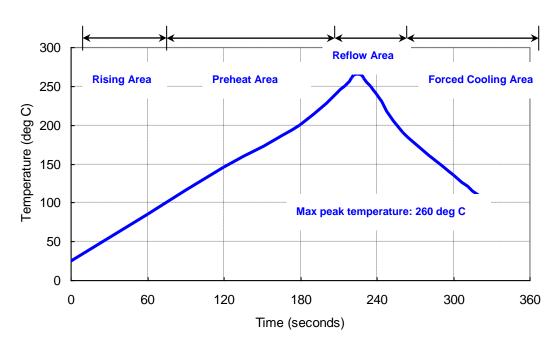
Tape Dimension



Packing Quantity/Packing: 3K pcs maximum per reel



Reflow Profile:



Notes of the Usage:

- 1. Touch the solder iron at 260+/-5 deg C onto the leads for 10+/-2 sec max or touch the solder at 350+/-5 deg C onto the leads for 3+/-0.5 sec.
- 2. In the customer's reflow process, if it will remain some mechanical stress at the soldering terminals, also make some cracks on the soldering termination. Some cracks will cause open or short circuit and cause of thermal increasing or smoking. Don't make any excess mechanical stress to soldering points.
- 3. In case of giving a heavy shock to the products, it may make an open or short circuit and cause of thermal increasing and smoking. To avoid heavy shock impact applying to products is strictly required.
- 4. Ultrasonic cleaning should be avoided to prevent damage to the TCXO.
- 5. Do Not Use Ultrasonic-Wave Soldering or Wave Solder with Package Immersed in Solder.

Notes of the Storage:

- 1. To keep products under the condition at the room temperature (-5~35 deg C) with normal humidity (45~75%). Absorption of moisture and dewdrop may make inferiority of characteristics and a short circuit.
- Oxidization of terminals shall make the solderability more inferior. Dusts and corrosive gas will make a cause of the open or short circuit. Keep it in the clean place where is not in dusty and no corrosive gas.
- 3. Use the unti-static material to the storage package.
- 4. Don't put any excess weight to the TCXO in the storage process.
- 5. Don't move the product from the cold place to the hot place in the short time, otherwise it may make some dew-drop, then a short circuit may happen in case.
- Storage periods should be maximum 6 months under condition of above item 1 after delivery from TST factory.
- 7. Once open the bag, there is possibility of electrical characteristics deterioration due to absorption of moisture. So, please use parts within 7 days after opening the bag.
- 8. If you have to keep parts without using after opening the bag, please put the drying agent in the bag, fold the bag and keep it in the place where temperature and humidity are controlled (nitrogen atmosphere box etc.)

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Test name	Test process / method	Reference standard				
Mechanical characteristics						
resistance to Soldering heat	Temp./ Duration: 265°C /10sec ×2 times Total time: 4min.(IR-reflow)	EIAJED-4701				
(IR reflow)	,	-300(301)M(II)				
Vibration	Total peak amplitude : 1.5mm	MIL-STD 202G				
	Vibration frequency : 10 to 2000 Hz Sweep period : 20 minute	method 204				
	Vibration directions : 3 mutually perpendicular					
Mechanical	directions : 3 impacts per axis	MIL-STD 202G				
Shock	Acceleration: 6000g's, +20/-0%	method 213				
	Duration : 0.3 ms (total 18 shocks) Waveform : Half-sine					
Solderability	Solder Temperature:265±5°C	J-STD-002				
Co.ac.ac.ac.	Duration time: 5±0.5 seconds.	0 0 1 0 0 0 1				
	characteristics					
Thermal Shock	Heat cycle conditions	MIL-STD 883G				
	-55 $^{\circ}$ C (30min) ←→ 125 $^{\circ}$ C (30min) * cycle time : 1000 times	method 1010.8				
Humidity test	Temperature : 85 ± 2 °C	MIL-STD 202G				
·	Relative humidity: 85% Duration: 1000 hours	method 103				
Dry heat	Temperature : 125 ± 2 °C	MIL-STD 202G				
(Aging test)	Duration : 1000 hours	method 108A				
Cold resistance (Low Temp Storage	Temperature : -40 ± 3 °C Duration : 1000 hours	IEC 60068-2-1				